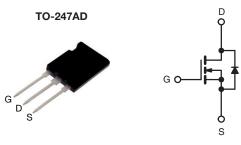
SiHW47N60E





E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.064		
Q _g max. (nC)	220			
Q _{gs} (nC)	36			
Q _{gd} (nC)	60			
Configuration	Single			



N-Channel MOSFET

FEATURES

- Low Figure-of-Merit (FOM) Ron x Qg
- Low Input Capacitance (C_{iss})
- Reduced Switching and Conduction Losses
- Ultra Low Gate Charge (Q_q)
- Avalanche Energy Rated (UIS)
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Switch Mode Power Supplies (SMPS)
- Power Factor Correction Power Supplies (PFC)
- Lighting
 - High-Intensity Discharge (HID)
 - Fluorescent Ballast Lighting
- Industrial
 - Welding
 - Induction Heating
 - Motor Drives
 - Battery Chargers
 - Renewable Energy
 - Solar (PV Inverters)

ORDERING INFORMATION	
Package	TO-247AD
Lead (Pb)-free and Halogen-free	SiHW47N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unless otherwis	se noted)			
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V _{DS}	600			
Gate-Source Voltage	V	± 20	V		
Gate-Source Voltage AC (f > 1 Hz)	V _{GS}	30			
Continuous Drain Current (T _J = 150 °C)	$T_{\rm C} = 25 ^{\circ}{\rm C}$	۱ _D	47		
	$V_{GS} \text{ at 10 V} \frac{T_C = 25 \text{ °C}}{T_C = 100 \text{ °C}}$		30	А	
Pulsed Drain Current ^a	I _{DM}	145	1		
Linear Derating Factor			3	W/°C	
Single Pulse Avalanche Energy ^b	E _{AS}	1500	mJ		
Maximum Power Dissipation	PD	357	W		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to + 150	°C		
Drain-Source Voltage Slope	T _J = 125 °C	dV/dt	37	V/ns	
Reverse Diode dV/dt ^d		uv/di	11	v/ns	
Soldering Recommendations (Peak Temperature)	for 10 s		300°	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

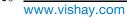
b. V_{DD} = 50 V, starting T_J = 25 °C, L = 73.5 mH, R_g = 25 $\Omega,$ I_{AS} = 6.4 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C.

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Available



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	40	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.33	0/11

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		-					
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA		600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I _D = 250 µA		0.66	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2	-	4	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V		-	± 100	nA
		V _{DS} = 600 V, V _{GS} = 0 V		-	-	1	μA
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 480 V	V _{DS} = 480 V, V _{GS} = 0 V, T _J = 150 °C		-	10	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 24 A	-	0.053	0.064	Ω
Forward Transconductance	g _{fs}	$V_{DS} = 8 V, I_D = 3 A$		-	6.8	-	S
Dynamic		-					
Input Capacitance	C _{iss}	V _{GS} = 0 V,		-	4810	-	pF
Output Capacitance	C _{oss}		$V_{\text{DS}} = 100 \text{ V},$ f = 1 MHz		230	-	
Reverse Transfer Capacitance	C _{rss}				5	-	
Total Gate Charge	Qg	1	V _{GS} = 10 V I _D = 24 A, V _{DS} = 480 V	-	147	220	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V		-	36	-	
Gate-Drain Charge	Q _{gd}			-	60	-	
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 480 \text{ V}, \text{ I}_{D} = 24 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.4 \Omega$		-	24	50	- ns
Rise Time	t _r			-	11	25	
Turn-Off Delay Time	t _{d(off)}			-	94	140	
Fall Time	t _f			-	13	26	
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	0.65	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	47	
Pulsed Diode Forward Current	I _{SM}			-	-	140	A
Diode Forward Voltage	V _{SD}	$T_{J} = 25 \text{ °C}, I_{S} = 24 \text{ A}, V_{GS} = 0 \text{ V}$		-	-	1.2	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = I _{S = 24 A} , dI/dt = 100 A/ μ s ^{. V} _R = 25 V		-	696	-	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	16	-	μC
Reverse Recovery Current	I _{RRM}				39	_	A

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= 10 V_{GS}

Shorted

140 160

80 100 120

= 1 MHz

400

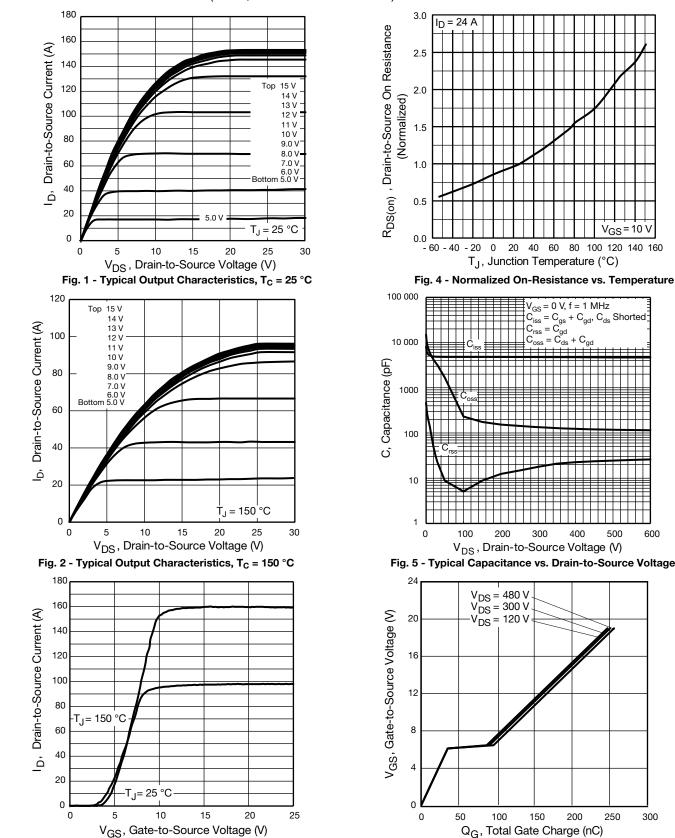
500

600

{gd}, C{ds}

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

S12-2357-Rev. A, 08-Oct-12

Fig. 3 - Typical Transfer Characteristics

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250

300

200

Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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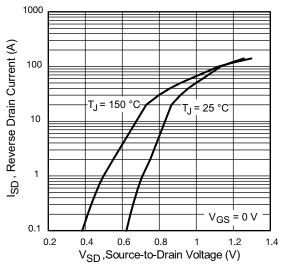


Fig. 7 - Typical Source-Drain Diode Forward Voltage

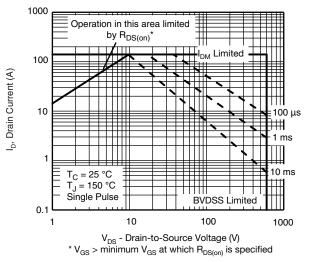
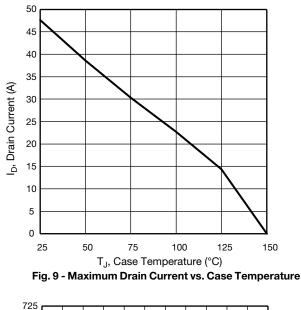


Fig. 8 - Maximum Safe Operating Area



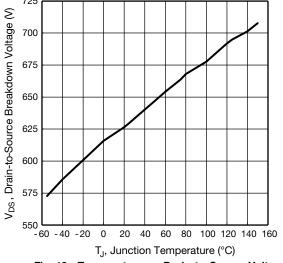
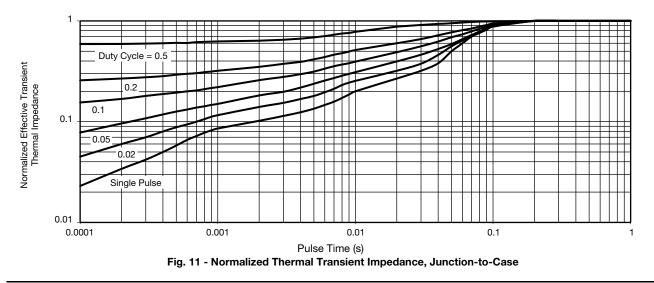


Fig. 10 - Temperature vs. Drain-to-Source Voltage



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4

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 V_{DS} R_{D} V_{GS} D.U.T. R_{G} V_{DD} D.U.T. V_{DD} V_{DS} V_{DD} V_{DS} V_{DD} V_{DS} V_{DD} V_{DS} V_{DD} V_{DS} V_{DD}

Fig. 12 - Switching Time Test Circuit

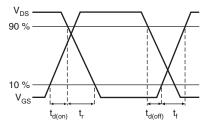


Fig. 13 - Switching Time Waveforms

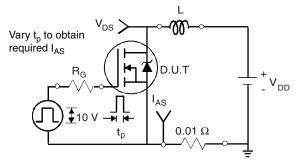
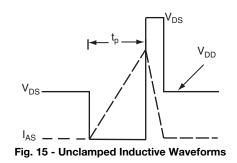


Fig. 14 - Unclamped Inductive Test Circuit



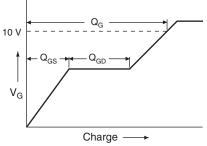


Fig. 16 - Basic Gate Charge Waveform

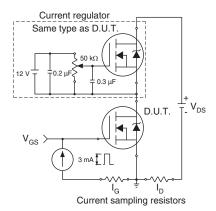


Fig. 17 - Gate Charge Test Circuit

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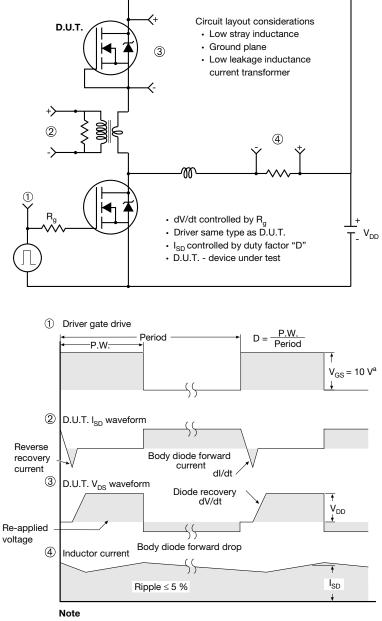
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 18 - For N-Channel

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